

# The RF Line

## NPN Silicon

### High-Frequency Transistor

... designed for thick and thin-film circuits using surface mount components and requiring low-noise, high-gain signal amplification at frequencies to 1.0 GHz.

- High Gain —  $G_{pe} = 15 \text{ dB Typ @ } f = 500 \text{ MHz}$
- Low Noise —  $NF = 2.4 \text{ dB Typ @ } f = 500 \text{ MHz}$
- Available in tape and reel packaging options by adding suffix:  
T1 suffix = 3,000 units per reel  
T3 suffix = 10,000 units per reel

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	15	Vdc
Collector-Base Voltage	$V_{CBO}$	20	Vdc
Emitter-Base Voltage	$V_{EBO}$	3.0	Vdc
Collector Current — Continuous	$I_C$	35	mAdc
Maximum Junction Temperature	$T_{Jmax}$	150	°C
Power Dissipation, $T_A = 75^\circ\text{C}^*$ Derate linearly above $75^\circ\text{C @}$	$P_{D(max)}$	0.268 3.57	W mW/°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Storage Temperature	$T_{stg}$	-55 to +150	°C
Thermal Resistance Junction to Case*	$R_{\theta JC}$	280	°C/W

\* Package mounted on 99.5% alumina 10 x 8 x 0.6 mm.

#### DEVICE MARKING

MMBR920LT1, T3 = 7B

#### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ( $I_C = 1.0 \text{ mAdc}$ , $I_E = 0$ )	$V_{(BR)CEO}$	15	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 0.1 \text{ mAdc}$ , $I_E = 0$ )	$V_{(BR)CBO}$	20	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 0.1 \text{ mAdc}$ , $I_C = 0$ )	$V_{(BR)EBO}$	2.0	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 10 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	—	50	nAdc

#### ON CHARACTERISTICS

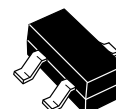
DC Current Gain ( $I_C = 14 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ )	$h_{FE}$	25	—	250	—
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#### SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product ( $I_C = 14 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 0.5 \text{ GHz}$ )	$f_T$	—	4.5	—	GHz
Collector-Base Capacitance ( $V_{CB} = 10 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{cb}$	—	—	1.0	pF
Noise Figure ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 0.5 \text{ GHz}$ ) ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ GHz}$ )	NF	— —	2.4 3.0	— —	dB
Common-Emitter Amplifier Power Gain ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 0.5 \text{ GHz}$ ) ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ GHz}$ )	$G_{pe}$	— —	15 10	— —	dB

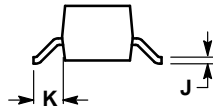
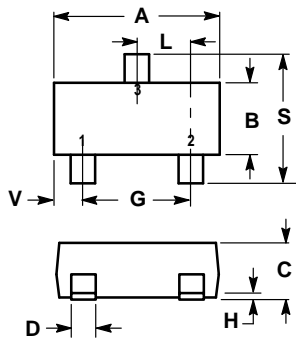
**MMBR920LT1, T3**

**RF AMPLIFIER  
TRANSISTOR  
NPN SILICON**



**CASE 318-07, STYLE 6  
SOT-23  
LOW PROFILE**

## PACKAGE DIMENSIONS




STYLE 6:  
PIN 1. BASE  
2. EMITTER  
3. COLLECTOR

### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0180	0.0236	0.45	0.60
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.0984	2.10	2.50
V	0.0177	0.0236	0.45	0.60

### CASE 318-07 ISSUE AD

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MMBR920LT1/D

